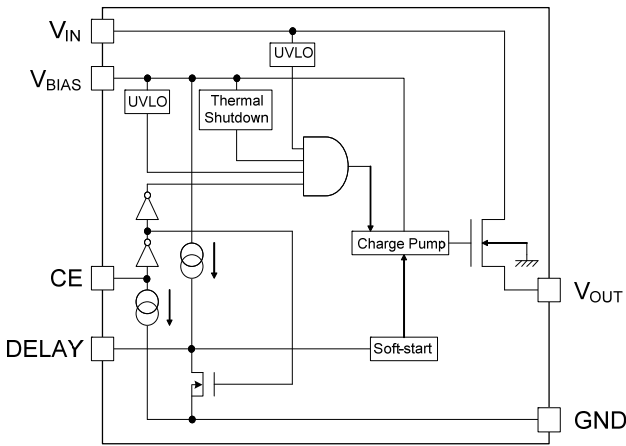
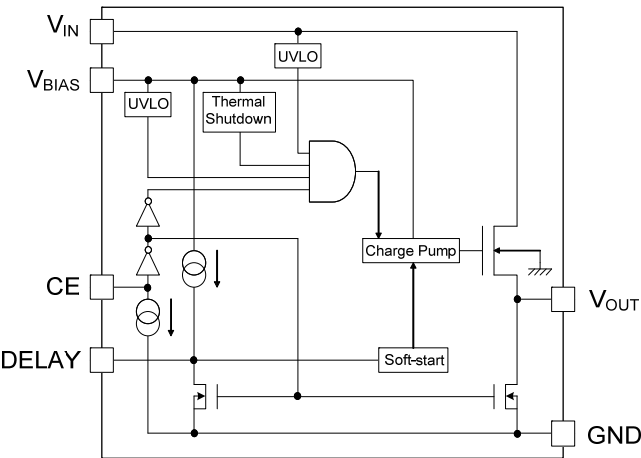


BLOCK DIAGRAMS



R5541K001B Block Diagram



R5541K001D Block Diagram

SELECTION GUIDE

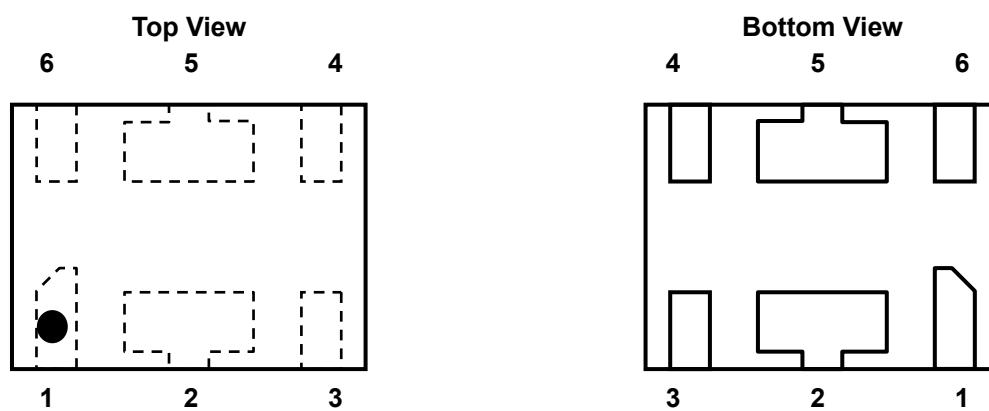
The auto-discharge function\*1 is a user-selectable option.

Selection Guide

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R5541K001*-E2	DFN(PLP)1216-6G	5,000 pcs	Yes	Yes
*: Specify the CE Pin Polarity and auto-discharge option.  B: Active-High, no auto-discharge function D: Active-High, auto-discharge function				

\*1 Auto-discharge function quickly lowers the output voltage to 0 V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.

## PIN DESCRIPTION



DFN(PLP)1216-6G Pin Configurations

### DFN(PLP)1216-6G Pin Description

Pin No.	Symbol	Description
1	CE	Chip Enable Pin (Active-High)
2	$V_{IN}$	Input Pin 2 <sup>*1</sup>
3	$V_{BIAS}$	Input Pin 1 <sup>*1</sup>
4	GND	Ground Pin
5	$V_{OUT}$	Output Pin
6	DELAY	DELAY Pin for Soft-start Setting

<sup>\*1</sup>  $V_{IN}$  should be used as  $V_{IN} \leq V_{BIAS}$ .

## ABSOLUTE MAXIMUM RATINGS

### Absolute Maximum Ratings

Symbol	Item	Rating	Unit
$V_{BIAS}$	$V_{BIAS}$ Pin Input Voltage	-0.3 to 6.0	V
$V_{IN}$	$V_{IN}$ Pin Input Voltage	-0.3 to 5.5	V
$V_{CE}$	CE Pin Input Voltage	-0.3 to 6.0	V
$V_{OUT}$	$V_{OUT}$ Pin Voltage	-0.3 to $V_{IN}$	V
$I_{OUT}$	Output Current	3.0	A
$P_D$	Power Dissipation (JEDEC STD.51-7 Test Land Pattern)*1	714	mW
$T_j$	Junction Temperature	-40 to 125	°C
$T_{stg}$	Storage Temperature Range	-55 to 125	°C

\*1 Refer to *PACKAGE INFORMATION* for detailed information.

### ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

### RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

## ELECTRICAL CHARACTERISTICS

$V_{BIAS} = 5.0\text{ V}$ ,  $V_{IN} = 1.0\text{ V}$ ,  $C_{BIAS} = 1\text{ }\mu\text{F}$ ,  $C_{IN} = \text{none}$ ,  $C_{OUT} = 0.1\text{ }\mu\text{F}$ , unless otherwise noted.

The specifications surrounded by   are guaranteed by Design Engineering at  $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$ .

## R5541K Electrical Characteristics

(Ta = 25°C)

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
$V_{BIAS}$	$V_{BIAS}$ Pin Input Voltage		<span style="border: 1px solid black; padding: 0 2px;">2.5</span>		<span style="border: 1px solid black; padding: 0 2px;">5.5</span>	V
$V_{IN}$	$V_{IN}$ Pin Input Voltage		<span style="border: 1px solid black; padding: 0 2px;">0.6</span>		<span style="border: 1px solid black; padding: 0 2px;">4.8</span>	V
$R_{ON}$	Switch ON Resistance	$I_{OUT} = 500\text{ mA}$		18	<span style="border: 1px solid black; padding: 0 2px;">28</span>	mΩ
$I_{SS}$	Supply Current	$I_{OUT} = 0\text{ mA}$ , $V_{BIAS}$ Pin		25	<span style="border: 1px solid black; padding: 0 2px;">47</span>	μA
Istandby	Standby Current	$V_{CE} = 0\text{ V}$ , $V_{IN} = 4.8\text{ V}$ , $V_{BIAS} = 5.5\text{ V}$		0.01	0.15	μA
		$V_{BIAS}$ Pin $V_{IN}$ Pin		0.01	1	μA
UVLO	Undervoltage Lockout Voltage	$V_{BIAS}$ Pin* <sup>1</sup>	<span style="border: 1px solid black; padding: 0 2px;">2.0</span>		<span style="border: 1px solid black; padding: 0 2px;">2.49</span>	V
		$V_{IN}$ Pin* <sup>2</sup>	<span style="border: 1px solid black; padding: 0 2px;">0.3</span>		<span style="border: 1px solid black; padding: 0 2px;">0.59</span>	V
$T_{TSD}$	Thermal Shutdown Temperature	Junction Temperature		145		°C
$T_{TSR}$	Thermal Shutdown Release Temperature	Junction Temperature		125		°C
$I_{CEPD}$	CE Pull-down Current			0.4	<span style="border: 1px solid black; padding: 0 2px;">0.8</span>	μA
$V_{CEH}$	CE Input Voltage "H"		<span style="border: 1px solid black; padding: 0 2px;">1.0</span>			V
$V_{CEL}$	CE Input Voltage "L"				<span style="border: 1px solid black; padding: 0 2px;">0.4</span>	V
$I_{DELAY}$	DELAY Pin Current	* <sup>3</sup>	<span style="border: 1px solid black; padding: 0 2px;">1.25</span>	1.5	<span style="border: 1px solid black; padding: 0 2px;">1.8</span>	μA
$R_{LOW}$	Low Output Nch Tr. ON Resistance (R5541K001D)	$V_{CE} = 0\text{ V}$		80		Ω

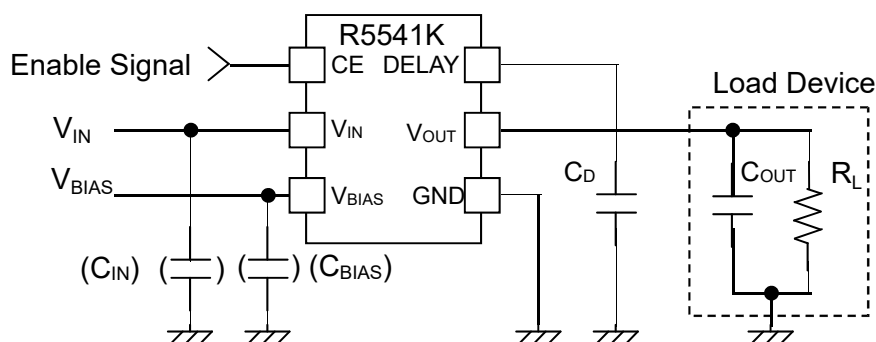
All test items listed under *ELECTRICAL CHARACTERISTICS* are done under the pulse load condition ( $T_j \approx T_a = 25^{\circ}\text{C}$ ).

\*<sup>1</sup> The UVLO detector threshold and the UVLO release voltage are between the min and the max of UVLO with Typ. 90 mV hysteresis.

\*<sup>2</sup> The UVLO detector threshold and the UVLO release voltage are between the min and the max of UVLO with Typ. 70 mV hysteresis.

\*<sup>3</sup> Soft-start time can be adjusted by using  $I_{DELAY}$  and a capacitor ( $C_D$ ). Refer to *Soft-start Function* in *TECHNICAL NOTES* for detailed Information.

## TYPICAL APPLICATION



**R5541K Typical Application**

## TECHNICAL NOTES

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. A peripheral component or the device mounted on PCB should not exceed a rated voltage, a rated current or a rated power. When designing a peripheral circuit, please be fully aware of the following points.

- An input capacitor ( $C_{IN}$ ) and a bypass capacitor ( $C_{BIAS}$ ) are NOT necessarily required between the  $V_{IN}$  pin and GND. If there is a possibility that the parasitic element (inductance) of  $V_{IN}$  may generate spike noise, connect an appropriate capacitor (about 0.1  $\mu$ F) between the  $V_{IN}$  pin and GND.
- $V_{IN}$  and  $V_{BIAS}$  should always be used as  $V_{IN} \leq V_{BIAS}$ .
- Connect the DELAY pin to a capacitor ( $C_D$ ) or leave the DELAY pin floating.

## SOFT-START FUNCTION

Soft-start function maintains the smooth control of the output voltage to prevent an inrush current during start-up by adjusting the soft-start time ( $t_{\text{start}}$ ) ( $V_{\text{OUT}} = 10\%$  to  $90\%$ ).  $t_{\text{start}}$  can be adjusted by connecting a capacitor ( $C_D$ ) between the DELAY pin and GND. The calculation of  $C_D$  is as follows.

$$C_D [\text{nF}] = 7.5 \times t_{\text{start}} [\text{ms}] \times I_{\text{DELAY}} [\mu\text{A}] / V_{\text{IN}} [\text{V}]$$

If  $C_D$  is not connected to the DELAY pin, leave the DELAY pin floating. If the DELAY pin is left floating, the calculation of the start-up time ( $t_r$ ) ( $V_{\text{OUT}} = 10\%$  to  $90\%$ ) is as follows.

$$t_r [\text{ms}] = 0.04 \times V_{\text{IN}} [\text{V}] (\text{Typ.})$$

$V_{\text{BIAS}}$ ,  $V_{\text{IN}}$  and CE can be sequenced in any order; the device can start up with soft-start function.

PACKAGE INFORMATION

POWER DISSIPATION (DFN(PLP)1216-6G)

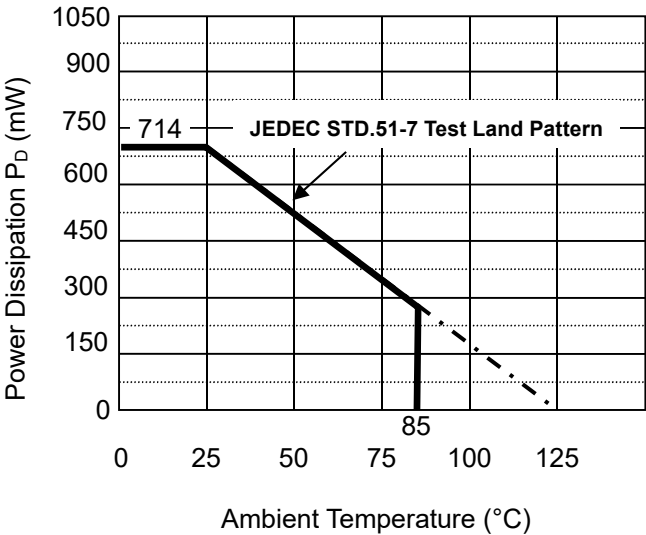
Power Dissipation ( $P_D$ ) of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.

Measurement Conditions

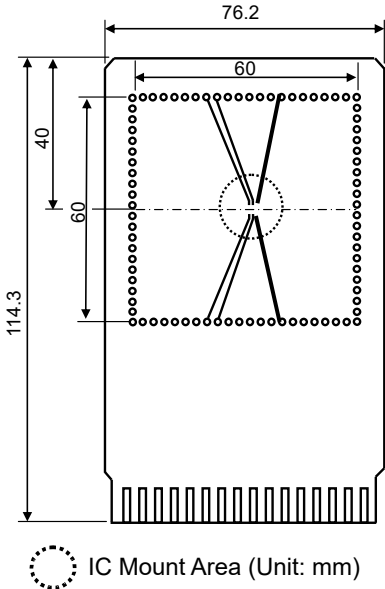
	JEDEC STD.51-7 Test Land Pattern
Environment	Mounting on Board (Wind Velocity = 0m/s)
Board Material	Glass Cloth Epoxy Plastic (4 Layer)
Board Dimensions	76.2 mm × 114.3 mm × 1.6 mm
Copper Ratio	Top side, Back side: 60 mm x 60mm, Approx.10% 2nd, 3rd layers: 74.2 mm x 74.2 mm, Approx. 100%
Through-holes	φ 0.85 mm x 44 pcs

Measurement Result (Ta = 25°C, Tjmax = 125°C)

	JEDEC STD.51-7 Test Land Pattern
Power Dissipation	714 mW
Thermal Resistance	$\theta_{ja} = (125 - 25^\circ\text{C}) / 0.714 \text{ W} = 140^\circ\text{C/W}$
	$\theta_{jc} = 21^\circ\text{C/W}$

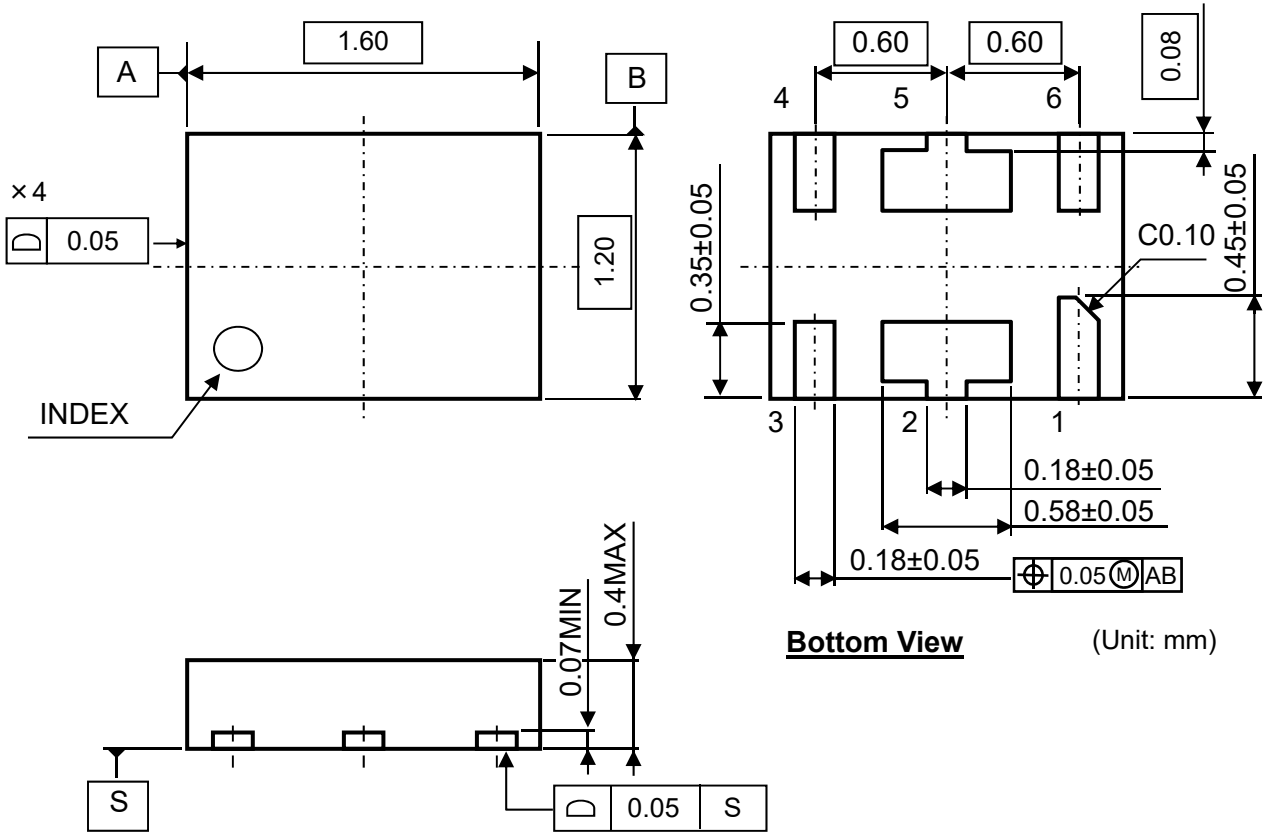


Ambient Temperature vs. Power Dissipation



Measurement Board Pattern

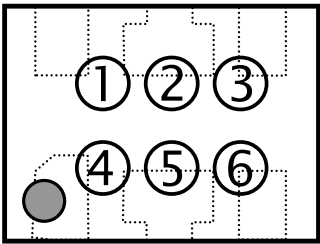
PACKAGE DIMENSIONS (DFN(PLP)1216-6G)



DFN(PLP)1216-6G Package Dimensions

MARK SPECIFICATION (DFN(PLP)1216-6G)

- ①②③④: Product Code ...**Refer to MARK SPECIFICATION TABLE DFN(PLP)1216-6G.**  
⑤⑥: Lot Number ...Alphanumeric Serial Number



DFN(PLP)1216-6G Mark Specification

MARK SPECIFICATION TABLE (DFN(PLP)1216-6G)

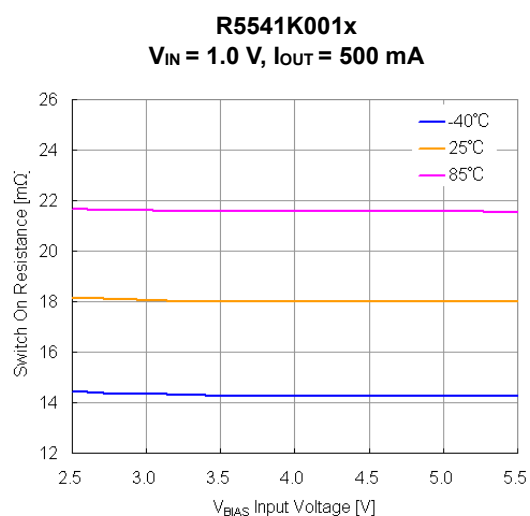
Mark Specification Table

Product Name	①②③④
R5541K001B	D Z 0 1
R5541K001D	D Z 0 3

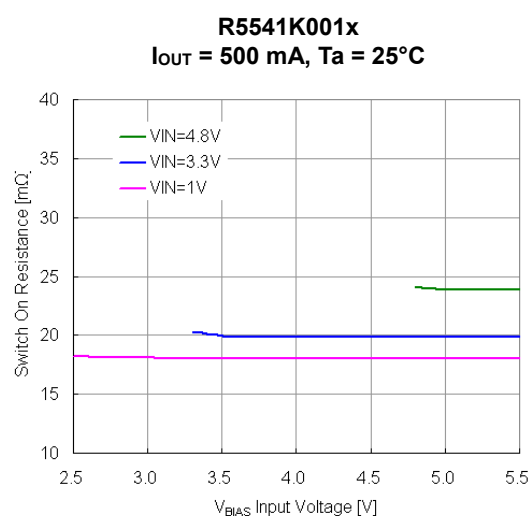


## TYPICAL CHARACTERISTICS

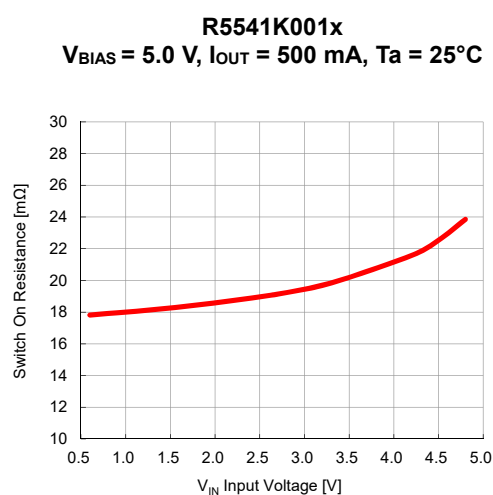
Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.



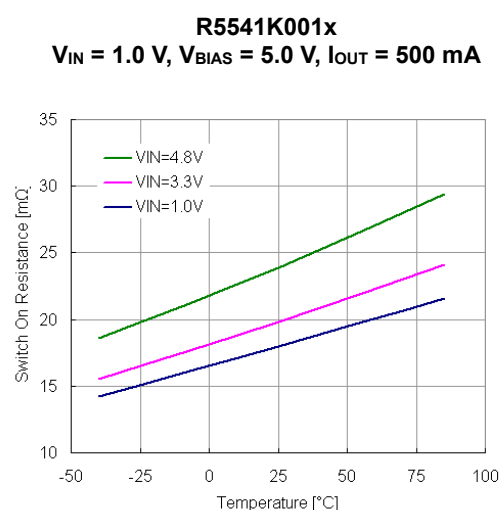
Switch On Resistance vs.  $V_{BIAS}$  Input Voltage



Switch On Resistance vs.  $V_{BIAS}$  Input Voltage

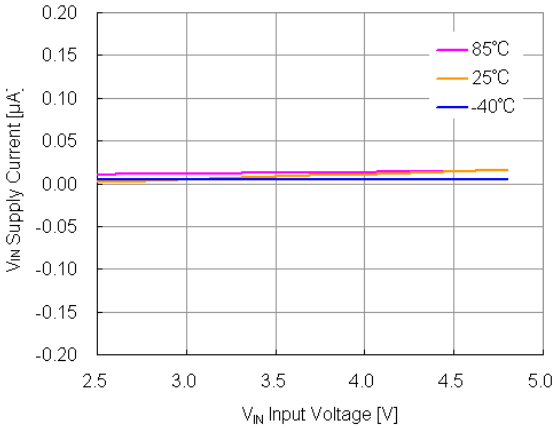


Switch On Resistance vs.  $V_{IN}$  Input Voltage



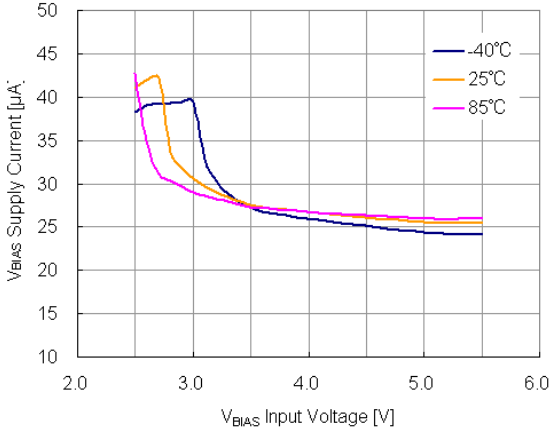
Switch On Resistance vs. Temperature

**R5541K001x**  
**V<sub>BIAS</sub> = 5.5 V**



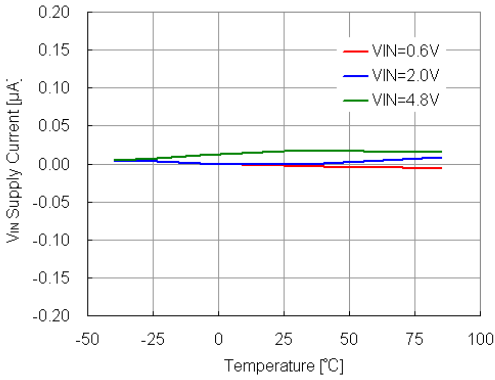
**V<sub>IN</sub> Supply Current vs. V<sub>IN</sub> Input Voltage**

**R5541K001x**  
**V<sub>IN</sub> = 1.0 V**



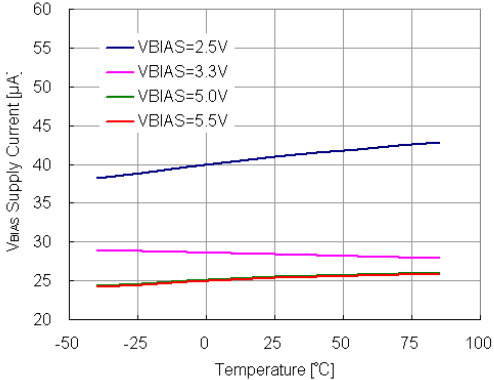
**V<sub>BIAS</sub> Supply Current vs. V<sub>BIAS</sub> Input Voltage**

**R5541K001x**  
**V<sub>BIAS</sub> = 5.5 V**



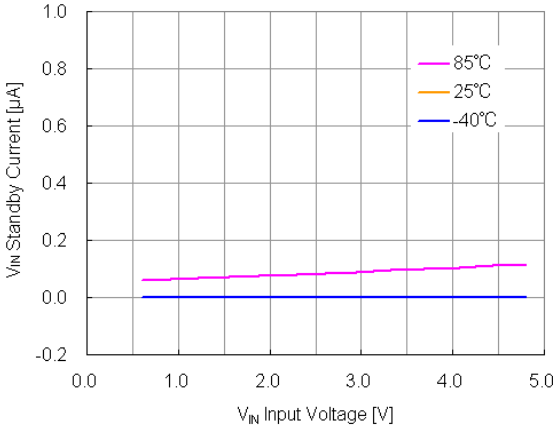
**V<sub>IN</sub> Supply Current vs. Temperature**

**R5541K001x**  
**V<sub>IN</sub> = 0.6 V**



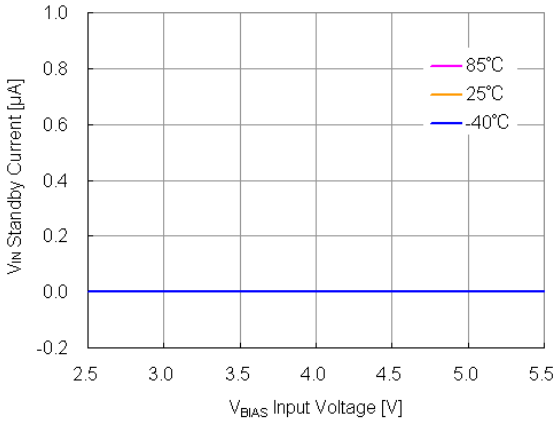
**V<sub>BIAS</sub> Supply Current vs. Temperature**

R5541K001x  
 $V_{BIAS} = 5.5\text{ V}$



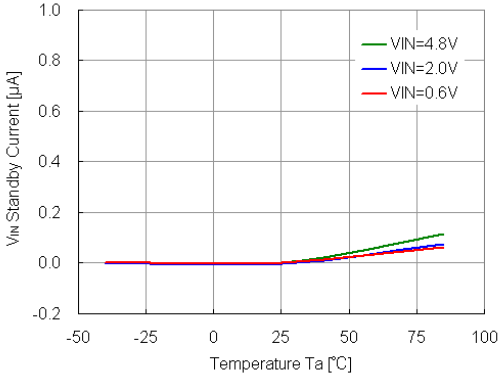
VIN Standby Current vs. VIN Input Voltage

R5541K001x  
 $V_{IN} = 0.6\text{ V}$



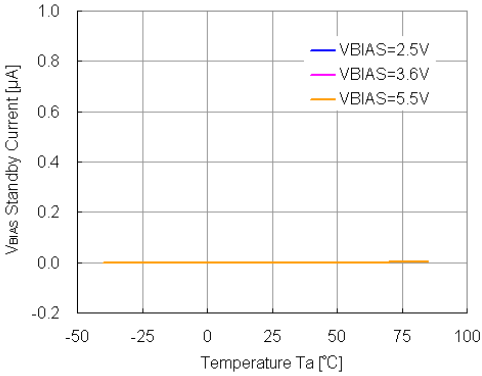
VIN Standby Current vs. VBIAS Input Voltage

R5541K001x  
 $V_{BIAS} = 5.5\text{ V}$



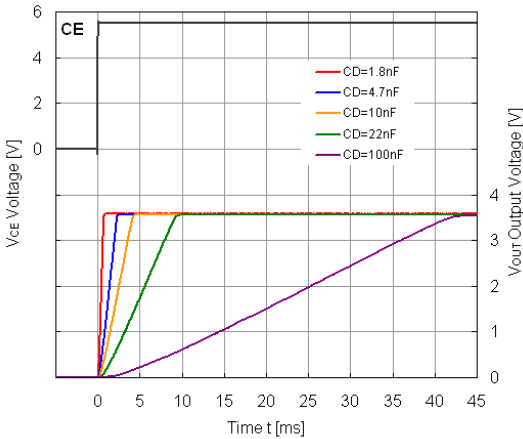
VIN Standby Current vs. Temperature

R5541K001x  
 $V_{IN} = 0.6\text{ V}$



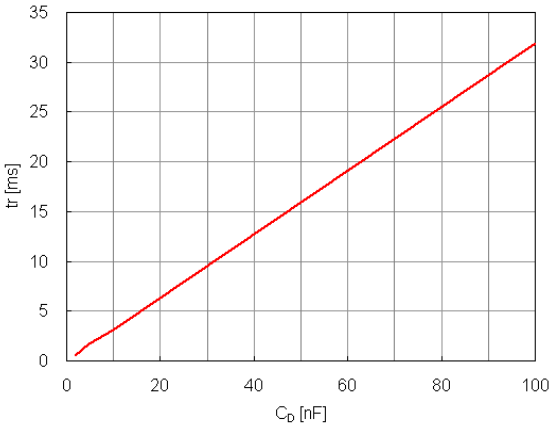
VBIAS Standby Current vs. Temperature

**R5541K001x**  
 **$V_{IN} = 3.6\text{ V}$ ,  $V_{BIAS} = 5.5\text{ V}$ ,  $R_{LOAD} = 10\ \Omega$ ,  $C_{OUT} = 0.1\ \mu\text{F}$**



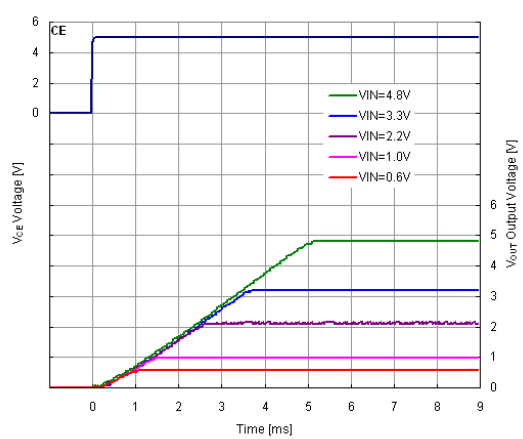
**$V_{OUT}$  Output Voltage On Time vs. DELAY Capacitance**

**R5541K001x**  
 **$V_{IN} = 3.6\text{ V}$ ,  $V_{BIAS} = 5.5\text{ V}$ ,  $R_{LOAD} = 10\ \Omega$ ,  $C_{OUT} = 0.1\ \mu\text{F}$**



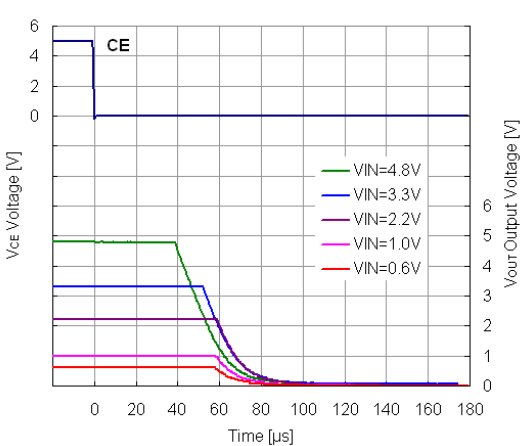
**tr vs. DELAY Capacitance**

**R5541K001x**  
 **$V_{BIAS} = 5.0\text{ V}$ ,  $C_D = 10\text{ nF}$ ,  $R_{LOAD} = 10\ \Omega$ ,  $C_{OUT} = 0.1\ \mu\text{F}$**



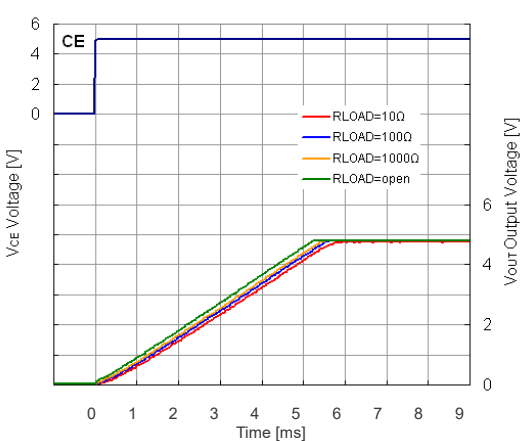
**$V_{OUT}$  Output Voltage On Time vs.  $V_{IN}$  Input Voltage**

**R5541K001D**  
 **$V_{BIAS} = 5.0\text{ V}$ ,  $C_D = 10\text{ nF}$ ,  $C_{OUT} = 0.1\ \mu\text{F}$**



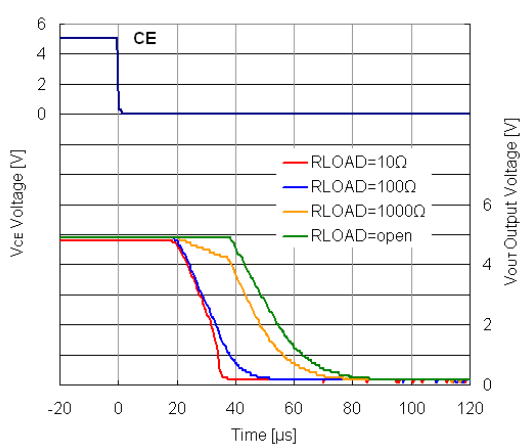
**$V_{OUT}$  Output Voltage Off Time vs.  $V_{IN}$  Input Voltage**

**R5541K001x**  
 **$V_{IN} = 4.8\text{ V}$ ,  $V_{BIAS} = 5.0\text{ V}$ ,  $C_D = 10\text{ nF}$ ,  $C_{OUT} = 0.1\ \mu\text{F}$**

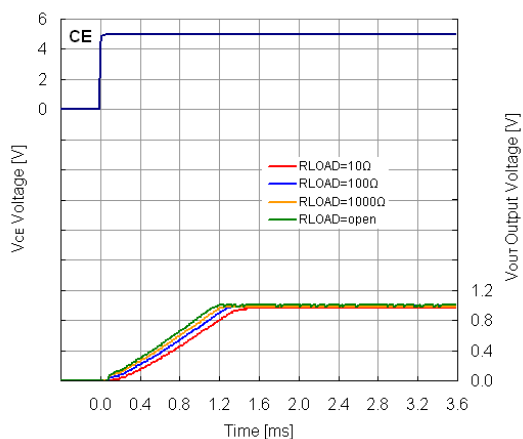
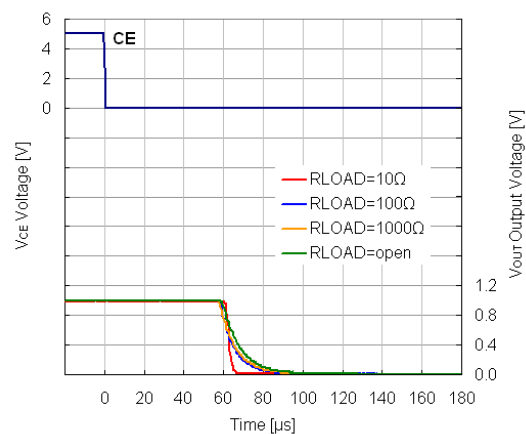
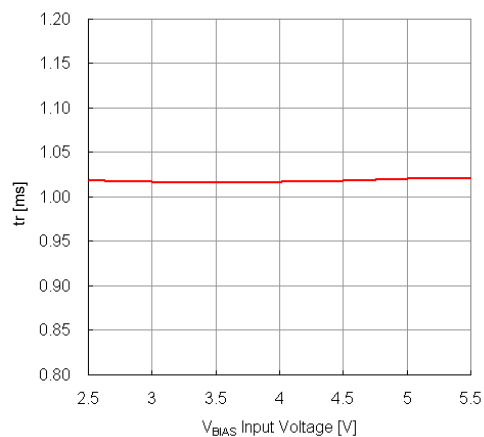
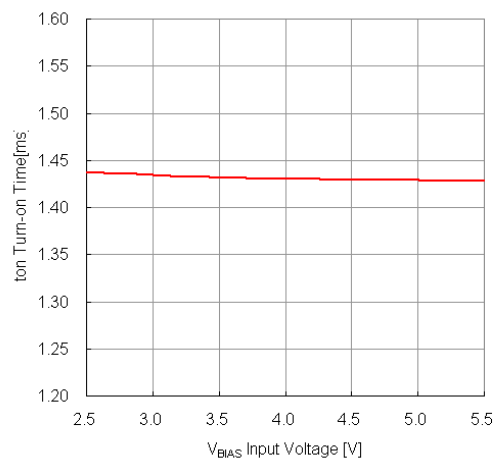
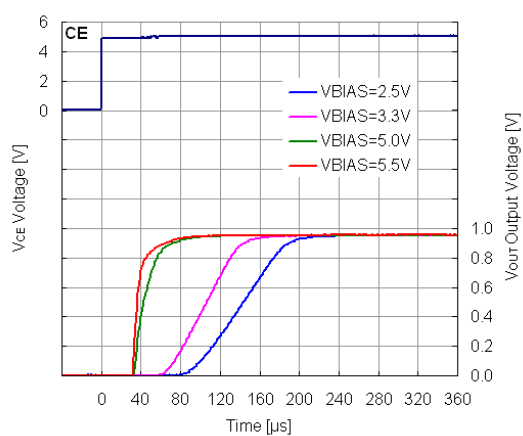


**$V_{OUT}$  Output Voltage On Time vs. Load Resistance**

**R5541K001D**  
 **$V_{IN} = 4.8\text{ V}$ ,  $V_{BIAS} = 5.0\text{ V}$ ,  $C_D = 10\text{ nF}$ ,  $C_{OUT} = 0.1\ \mu\text{F}$**



**$V_{OUT}$  Output Voltage Off Time vs. Load Resistance**

**R5541K001x** **$V_{IN} = 1.0\text{ V}$ ,  $V_{BIAS} = 5.5\text{ V}$ ,  $C_D = 10\text{ nF}$ ,  $C_{OUT} = 0.1\text{ }\mu\text{F}$** **V<sub>OUT</sub> Output Voltage On Time vs. Load Resistance****R5541K001D** **$V_{IN} = 1.0\text{ V}$ ,  $V_{BIAS} = 5.5\text{ V}$ ,  $C_D = 10\text{ nF}$ ,  $C_{OUT} = 0.1\text{ }\mu\text{F}$** **V<sub>OUT</sub> Output Voltage Off Time vs. Load Resistance****R5541K001x** **$V_{IN} = 1.0\text{ V}$ ,  $C_D = 10\text{ nF}$ ,  $R_{LOAD} = 10\text{ }\Omega$ ,  $C_{OUT} = 0.1\text{ }\mu\text{F}$** **tr vs. V<sub>BIAS</sub> Input Voltage****R5541K001x** **$V_{IN} = 1.0\text{ V}$ ,  $C_D = 10\text{ nF}$ ,  $R_{LOAD} = 10\text{ }\Omega$ ,  $C_{OUT} = 0.1\text{ }\mu\text{F}$** **ton Turn-on Time vs. V<sub>BIAS</sub> Input Voltage****R5541K001x** **$V_{IN} = 1.0\text{ V}$ ,  $R_{LOAD} = 10\text{ }\Omega$ ,  $C_{OUT} = 0.1\text{ }\mu\text{F}$** **V<sub>OUT</sub> Output Voltage On Time vs. V<sub>BIAS</sub> Input Voltage**



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